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Design of Sub Threshold Flip Flop For Ultra Low Power Applications

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Abstract: Power consumption is considered as one of the important challenge in modern VLSI design along with area and speed consideration. Flip flop plays very important role in digital systems. In this paper comparative study of four different flip flops which includes pulse triggered as well as conditional technique flip flop such as IP-DCO, MHLFF, CPSFF, and CPFF topologies in sub threshold operation are examined. In recent years the ultra low power application can be possible using sub threshold technology. Using the advantage of this technology the power consumption of these flip flops is minimized. Sub threshold circuit consume less power than strong inversion circuit at the same frequency. Design is done using HSPICE in TSMC 180nm technology. The flip flops are analysed in all corners and parameters such as delay, power delay product, Energy delay product, and average power is measured at power supply voltage 300mV, and applied clock frequency is 1 MHz at temperature of $27^{0}C$

Keywords: Sub threshold technology, flip flop, low power.

I. INTRODUCTION

As stated by International Technology Roadmap for Semiconductor power consumption is considered as one of the important challenge in VLSI along with speed and area consideration. Different ways for reducing the power consumption have been proposed. In all these challenging methods minimizing power supply voltage gives direct and effect on reducing power consumption [1]. Flip flops are major building blocks in digital VLSI system. The applications areas where flip flops are majorly used are in registers, pipelines, state machines for sequencing data. Flip flop have direct impact on power consumption and speed of VLSI system. Flip flop and latches consume more power because of redundant transitions & clocking system which is included in it. Thus our aim is to design high performance and also power efficient flip flop. One of the challenging methods to design low power flip flop is to use sub threshold technology.

Power consumption of circuit depends on several factors such as data activity, frequency, supply voltage, capacitance leakage and short circuit current. The total power dissipation is given by the sum of static and dynamic power dissipation. Amongst them dynamic power is one of the important and it is given by,

PDynamic = $0.5. \alpha$ CL.VDD2.f(1)

Where α is the probability of signal transition within clock period, C_L is the load capacitance, V_{DD} is the power supply voltage, f is clock frequency. Hence by reducing the power supply voltage there is tremendous reduction in power consumption of circuit.

When supply voltage VDD reduces below the transistor threshold voltage V_T , it is said to operate insub threshold region. This is one of the efficient methods for low power application in which the performance is of sec-ondary importance [2][3]. As power supply voltage is reduced below the transistors supply voltage V_T , the sub threshold current slowly charges and discharges nodes for circuits logic function. This weak driving current limits the per-formance but low energy operation can be achieved with reduced dynamic &leakage power, resulting in improvingbattery life. In sub threshold region due to absence of conducting inversion channels, transistors behave differently thanin strong inversion region. Thus resulting circuit characteristics change accordingly. Sub threshold technology can beused in various applications such as wearable medical equipments such as hearing aids & pace makers, wrist watchCopyright to IJIRSETWww.ijirset.com



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computers, self powered devices & wireless sensor networks.[4][5]. One more application of sub threshold circuits is in bursty mode application, which is ideal for a long period of time. In sub threshold circuit it satisfies the ultra power requirement. The reason behind this is that it uses leakage current for its operating switching current. This small leakage current however affects the performance at which the circuit is operated.

Section II gives details of flip flops; Section III gives the simulation, Section IV gives the results, Section V conclusion.

II. PROPOSED FLIP FLOP DESIGNS

As power consumed by clock distribution network & storage element is high, pulse triggered flip flop has been considered as popular alternative to conventional master slave flip flop. Circuit simplicity and high speed is the advantage of pulse triggered flip flop which is more advantageous for low power consumption of clock tree system.

One of the other alternatives to reduce power in flip flop is to reduce number of clocking transistors. So both types of flip flops are taken in this paper and their result is compared by parameters such as average power, Power delay product, time delay, number of transistors in new technology i.e. sub threshold technology.

A. Implicit Pulsed Data Closed To Output:

A P-FF consists of pulse generator to generate strobe signal & latch circuit to store the data. Implicit pulse generation is more advantageous for power consideration because it first controls discharging path and then needs to physically generate a pulse train. Fig 1 shows IP-DCO. It contains an AND logic pulse generator and semi dynamic structured latch design. In these circuit inverters $I_5 \& I_6$ are used to hold the data & inverters $I_7 \& I_8$ are used to hold the internal node X. Two practical problems exist in this design of IP-DCO. First during rising edge of clock signal nmos transistors N_2 and N_3 are turned on. If data remains high, node X will be discharged on every rising edge of clock. This leads to large switching power. The other problem is that node X controls two larger MOS transistors (P₂ & N₅). The large capacitive load to nodeX causes speed and power performance degradation [6].

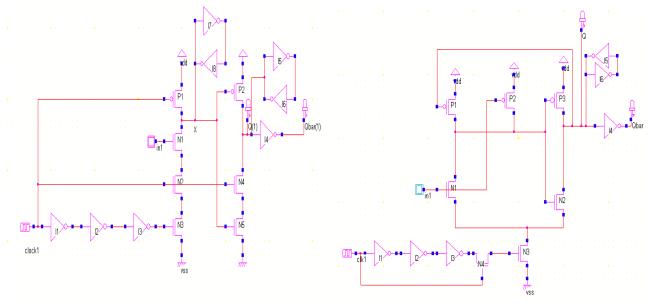


Fig1: Implicit Pulse Data Close to Output flip flop

Fig 2: Modified Hybrid Latch Flip-Flop

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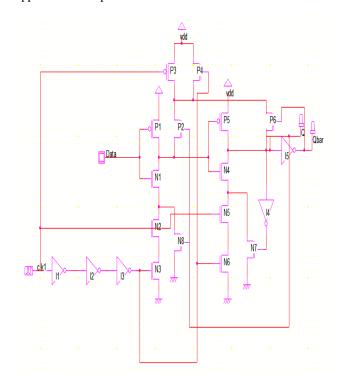
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B. Modified Hybrid Latch Flip Flop:

In Modified Hybrid Latch flip flop shown in Fig 2, node transistors occur only when input has different logic value in two successive clocks. It uses feedback to remember instead of depending charge on capacitor a static latch structure. A static latch can remember as long as gate power is supplied. In MHLFF redundant transitions are avoided. The MHLFF eliminates the problem of discharging at node X. In second stage of MHLFF it has simple static latch structure. By using feedback path, unnecessary discharging problem of internal node is reduced [6]

C. Conditional Pre charge Flip Flop:

Conditional Precharge Flip Flop proposed [7] [8] and shown in Fig 3. In this odd numbers of inverters are used in clock path to generate a transparency window as like in MHLFF. The important advantage of this work is associated to preventing unconditional pre-charge operation of internal node, connected to excessive power dissipation of circuit. This avoids the unnecessary transition of internal node as well as race condition at output. When D input is high during transparency window it results in driving internal node to GND. It then sets the output Q to high level. As internal node is at low level it remains at low level till input is at high level. To switch the internal node to high level input transition should change from high to low in clock cycle. Internal node state is captured by second stage in flip flop. When high to low transition occurs at internal node the low level is captured unconditionally and is synchronous with clock edge. But the exception for this case is internal node transition which occurs after low to high switching input when Q is at high level regardless of state of clock. Holding the output signal at desired level is done by use of conditional keepers. When clock signal or delayed clock signal is low at that time high level output is held. Similar case happens when output is at low level.



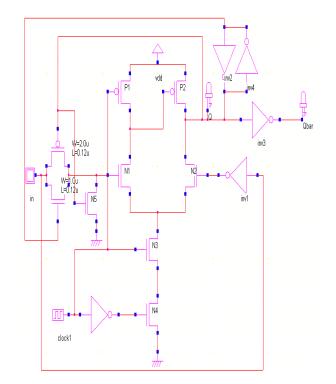


Fig.4: Clock Paired shared Flip Flop

Fig. 3: Conditional Precharge Flip Flop

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D. Clock Paired Shared Flip Flop:

The Clock paired shared flip flop is proposed [9] uses less number of clocked transistors (i.e. only 4 out of 19 transistors) due to which clock load is decreased and it becomes efficient design. Hence it is improved version of conditional data mapping flip flop. Clock pair transistors i.e. N_3 and N4 are used for the first and second stage sharing purpose. P_1 transistor is used to charge internal node X which helps in avoiding floating problem. The flip flop operates when CLK and CLKDB is at high logic. The working of CPSFF not only depends on data and clock but also on previous input Q and Qb_kpr. So initial condition for working of CPSFF should be when D input is high, the previous state of output should be low and the signal Qb_kpr should be high or all signals can be applied as vice versa.

III. SIMULATION

A comparative study of above flip flop cells are performed with respect to parameters such as delay, power consumption, power delay product, energy delay product. The simulation results for above types of flip flop were obtained using HSPICE simulator. The operating conditions for design of the flip flop are VDD=300mV, clock and input data frequency applied is 1MHz, temperature is 27°C. The technology used for the flip flop design is TSMC 180 nm. The parasitic capacitances were extracted from layouts to simulate circuit accurately.

By eliminating parasitic capacitances we can avoid delay which depends on these capacitances and more over power consumption also. Fig.5 shows the delay time variation of flip flops. It is seen fro the graph that MHLFF is having less delay as compared to other flip flops. Fig. 5 shows the average power consumption of flip flop. The average power consumption is very less in CPSFF and MHLFF is having higher power consumption in our all four flip flop designs. Fig 6. Is having comparison of power delay product. Fig 7 gives the variations in average power for flip flop types. The value of CPSFF is lower than other flip flops. It shows that CPSFF gives the best performance amongst these four flip flops. Table- I and Table II shows the results of sub threshold flip flop in 180nm technology at Vdd=0.3V

TABLE-I FLIP-FLOP CHARACTERISTICS COMPARISION IN TERMS OF DELAY, POWER, AND POWER DELAY PRODUCT AT VDD=300mV, 180nm TECHNOLOGY

SR. NO	NAME OF FLIP FLOP	T _{DELAY} (us)	AVG POWER (uw)	PDP (pJ)	EDP (aJ)
1	MHLFF	0.0216	5.6700	0.12249	0.002646
2	IP-DCO	0.1927	0.5009	0.09656	0.01861
3	CPSFF	0.4094	0.1851	0.07581	0.031045
4	CPFF	0.4110	0.3203	0.13166	0.005411

TABLE-II FLIP-FLOP CHARACTERISTICS W and L USED FOR DESIGN AND RISE AND FALL TIME VDD=300mV, 180nm TECHNOLOGY

SR. NO.	NAME OF FLIP FLOP	NO OF TRANSISTORS	W(P)(u)	L(P)(u)	W(N)(u)	L(N)(u)	T _{RISE} (ns)	T _{FALL} (ns)
1	IP-DCO	23	0.14	0.14	0.14	0.14		
2	MHLFF	19	0.18	0.13	0.18	0.13	29.400	27.520
3	CPSFF	19	0.17	0.14	0.17	0.14	12.261	5.5561
4	CPFF	23	0.14	0.14	0.14	0.14	10.312	4.8733

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IV.RESULTS

Table –I shows the results of simulated flip flop. In these flip flops Modified Hybrid latch flip flop is having lower time delay as compared to others. The average power of Clock Paired Shared flip flop is having lowest power consumption. Hence if power consumption is considered the performance of CPSFF is better. The power delay product value is also best for CPSFF. Hence as the comparison result is considered the CPSFF will give better performance than other three flip flops due to less number of clocking transistors. The graphs for these results are shown below. It gives the detailed comparison of time delay , average power and power delay product.

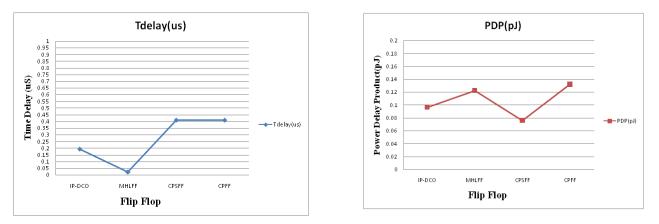


Fig.5 The delay time variations in flip flop types.

Fig 6. Comparison of power delay product in flip flop types.

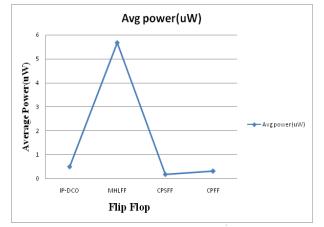


Fig 7: Graph showing of average power in flip flop

IV. CONCLUSION

In this paper flip flop designs i.e. Implicit Pulsed flip flop, Modified Hybrid Latch Flip Flop, Conditional Precharge and Clock Paired Shared Flip Flop are discussed in sub threshold region in 180 nm technology. We can see from above discussion that flip flop can still function well when power supply voltage reduces below its threshold voltage. In this firstly W/L ratio for



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transistors is not known. Hence different ratios would get different timing and power result. Secondly accuracy of technology file can give different results. Here I have used 180nm technology PTM model. Hence different tool can give different result. To get more improvement in results in future we can reduce the supply voltage and more over other technologies can be used.

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REFERENCES

- [1] J. Rabaey, M. Pedram, and P. Landman, Low Power Design Methodologies. Boston: Kluwer Academic Publishers, 1995.
- [2] A. Wang and A. Chandrakasan, "A 180 mV sub threshold FFT processor using a minimum energy design methodology," IEEE J. Solid-State Circuits, vol. 40, pp. 310–319, Jan. 2005
- [3] R. M. Swanson and J. D. Meindl, "Ion-implanted complementary MOS transistors in low-voltage circuits," IEEE J. S. S. C., vol. 7, pp. 146– 153, Apr. 1972.
- [4] H. Soeleman and K. Roy, "Ultra-low power digital sub threshold logic circuits," in Proc. Low Power Electronics and Design, 1999, pp. 94–96.
- [5] L. Nazhandali et al., "Energy optimization of sub threshold-voltage sensor network processors," in Proc. Intl. Symp. on Computer Architecture, 2005, pp. 197–207.
- [6] Yin-Tsung Hwang, Jin-Fa Lin, and Ming-Hwa Sheu," Low-Power Pulse-Triggered Flip-Flop Design With Conditional Pulse-Enhancement Scheme" IEEE Transactions On Very Large Scale Integration (VLSI) Systems, Vol. 20, No. 2, Feb
- [7] N.Nedovic, M.Aleksic, V.G. Oklobdzijia, "Conditional Precharge Techniques for Power-Efficient Dual-Edge Clocking" Int. Symp. Low-Power Electronics, Design, Monterey, CA, pp.56-59, Aug.2000
- [8] Y. Zhang, H. Yang, and H. Wang, "Low clock-swing conditional precharge flip-flop for more than 30% power reduction," Electron. Lett., vol. 36, no. 9, pp. 785–786, Apr.2000
- [9] D. Markovic, B. Nikolic and R.W. Brodersen, "Analysis and design of low-energy flipflops," Int. Symp. Low Power Electronics and DESIGN PP 51-55 AUG 2001.
- [10] N. H. E. Weste and D. Harris, CMOS VLSI Design A Circuits and Systems Perspective Boston, MA: Addison Wesley, 2005.
- [11] Predictive Technology Model

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